- Members of the Texas Instruments Widebus+ ${ }^{\text {TM }}$ Family
- State-of-the-Art EPIC-IIBTM BiCMOS Design Significantly Reduces Power Dissipation
- UBE ${ }^{T M}$ (Universal Bus Exchanger) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, or Clocked Mode
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical Volp (Output Ground Bounce) $<0.8 \mathrm{~V}$ at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
- High-Impedance State During Power Up and Power Down
- Distributed $\mathrm{V}_{\mathrm{CC}}$ and GND Pin Configuration Minimizes High-Speed Switching Noise
- High-Drive Outputs ( $-32-\mathrm{mA} \mathrm{I}_{\mathrm{OH}}, 64-\mathrm{mA} \mathrm{I}_{\mathrm{OL}}$ )
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include 80-Pin Plastic Thin Quad Flat (PN) Package With $12 \times 12-\mathrm{mm}$ Body Using $0.5-\mathrm{mm}$ Lead Pitch and 84-Pin Ceramic Quad Flat (HT) Package




## description

The 'ABTH32318 consist of three 18-bit registered input/output (I/O) ports. These registers combine D-type latches and flip-flops to allow data flow in transparent, latch, and clock modes. Data from one input port can be exchanged to one or more of the other ports. Because of the universal storage element, multiple combinations of real-time and stored data can be exchanged among the three ports.
Data flow in each direction is controlled by the output-enable ( $\overline{\mathrm{OEA}}, \overline{\mathrm{OEB}}$, and $\overline{\mathrm{OEC}}$ ), select-control (SELA, SELB, and SELC), latch-enable (LEA, LEB, and LEC), and clock (CLKA, CLKB, and CLKC) inputs. The A data register operates in the transparent mode when LEA is high. When LEA is low, data is latched if CLKA is held at a high or low logic level. If LEA is low, data is stored on the low-to-high transition of CLKA. Output data selection is accomplished by the select-control pins. All three ports have active-low output enables, so when the output-enable input is low, the outputs are active; when the output-enable input is high, the outputs are in the high-impedance state.

When $\mathrm{V}_{\mathrm{CC}}$ is between 0 and 2.1 V , the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V , $\overline{\mathrm{OE}}$ should be tied to $\mathrm{V}_{\mathrm{CC}}$ through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

# SN54ABTH32318, SN74ABTH32318 

 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS
## description (continued)

The SN54ABTH32318 is characterized for operation over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The SN74ABTH32318 is characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

Function Tables
storage $\dagger$

| INPUTS |  |  | OUTPUT |
| :---: | :---: | :---: | :---: |
| CLKA | LEA | A |  |
| $\uparrow$ | L | L | L |
| $\uparrow$ | L | H | H |
| H | L | X | $\mathrm{Q}_{0} \ddagger$ |
| L | L | X | $\mathrm{Q}_{0} \ddagger$ |
| X | H | L | L |
| X | H | H | H |

$\dagger$ A-port register shown. B and C ports are similar but use CLKB, CLKC, LEB, and LEC.
$\ddagger$ Output level before the indicated steady-state input conditions were established

| A-PORT OUTPUT |  |
| :---: | :---: |
| INPUTS  OUTPUT A <br> $\overline{\text { OEA }}$ SELA  <br> $H$ X Z <br> L $H$ Output of register <br> L L Output of B register |  |


| B-PORT OUTPUT |  |
| :---: | :---: |
| INPUTS  OUTPUT B <br> $\overline{\text { OEB }}$ SELB  <br> $H$ X Z <br> L $H$ Output of A register <br> L L Output of C register |  |


| C-PORT OUTPUT |  |
| :--- | :---: |
| INPUTS  OUTPUT C <br> $\overline{\text { OEC }}$ SELC  <br> $H$ X Z <br> L $H$ Output of B register <br> L L Output of A register |  |

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logic diagram (positive logic)


Pin numbers shown are for the PN package.

## SN54ABTH32318, SN74ABTH32318 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\dagger$ 

| S | -0.5 V to 7 V |
| :---: | :---: |
| Input voltage range, $\mathrm{V}_{1}$ (except I/O ports) (see Note 1) | -0.5 V to 7 V |
| Voltage range applied to any output in the high or power-off state | -0.5 V to 5.5 V |
| Current into any output in the low state, $\mathrm{I}_{\mathrm{O}}$ : SN54ABTH32318 | 96 mA |
| SN74ABTH32318 | 128 mA |
| Input clamp current, $\mathrm{I}_{\mathrm{IK}}\left(\mathrm{V}_{1}<0\right)$ | -18 mA |
| Output clamp current, $\mathrm{I}_{\mathrm{OK}}\left(\mathrm{V}_{\mathrm{O}}<0\right)$ | $-50 \mathrm{~mA}$ |
| Package thermal impedance, $\theta_{\mathrm{JA}}$ (see Note 2): PN package | 62 ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Storage temperature range, $\mathrm{T}_{\text {stg }}$ | $5^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| resses beyond those listed under "absolute maximum ratings" may cause permanen nctional operation of the device at these or any other conditions beyond those ind plied. Exposure to absolute-maximum-rated conditions for extended periods may | ess ratings only, and g conditions" is not |
| ES: 1. The input and output negative-voltage ratings may be exceeded if the in | are observed. |

recommended operating conditions (see Note 3)


NOTE 3: Unused control pins must be held high or low to prevent them from floating.
electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

$\dagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
$\ddagger$ This parameter is specified by characterization.
§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
TThis is the increase in supply current for each input that is at the specified TTL voltage level rather than $V_{C C}$ or GND.
timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)


## SN54ABTH32318, SN74ABTH32318 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | SN54ABTH32318 | SN74ABTH32318 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN MAX | MIN | MAX |  |
| $f_{\text {max }}$ |  |  | 150 | 150 |  | MHz |
| tPLH | A, B, or C | C, B, or A | 1.46 .5 | 1.4 | 6.1 | ns |
| tPHL |  |  | 1.16 .8 | 1.1 | 6.6 |  |
| tPLH | SEL | A, B, or C | $1.4 \quad 6.7$ | 1.4 | 6.5 | ns |
| tPHL |  |  | 1.8 6.8 | 1.8 | 6.5 |  |
| tPLH | LE | A, B, or C | $2.6 \times 8$ | 2.6 | 7.5 | ns |
| tPHL |  |  | 2.6 7.4 | 2.6 | 6.9 |  |
| tPLH | CLK | A, B, or C | 2.58 | 2.5 | 7.4 | ns |
| tPHL |  |  | 2.57 .2 | 2.5 | 6.7 |  |
| tPZH | $\overline{\mathrm{OE}}$ | A, B, or C | Q 1.46 .9 | 1.4 | 6.8 | ns |
| tPZL |  |  | $2.4 \quad 7.2$ | 2.4 | 7.1 |  |
| tPHZ | $\overline{\mathrm{OE}}$ | A, B, or C | $1 \quad 6.4$ | 1 | 6.2 | ns |
| tplZ |  |  | 26.4 | 2 | 6 |  |

PARAMETER MEASUREMENT INFORMATION


LOAD CIRCUIT


VOLTAGE WAVEFORMS
PULSE DURATION


VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS

| TEST | S1 |
| :---: | :---: |
| $\mathrm{t}^{\mathrm{t} L H} / \mathrm{t}_{\mathrm{PHL}}$ | Open |
| $\mathrm{t}_{\mathrm{PLZ}} / \mathrm{t} \mathrm{PZL}$ | 7 V |
| $\mathrm{t}_{\mathrm{PHZ}} / \mathrm{t}$ PZH | Open |



VOLTAGE WAVEFORMS SETUP AND HOLD TIMES


VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 2.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2.5 \mathrm{~ns}$.
D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead finish/ Ball material (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74ABTH32318PN | ACTIVE | LQFP | PN | 80 | 119 | RoHS \& Green | NIPDAU | Level-3-260C-168 HR | -40 to 85 | ABTH32318 | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: Tl defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.
*All dimensions are nominal

| Device | Package <br> Name | Package <br> Type | Pins | SPQ | Unit array <br> matrix | Max <br> temperature <br> $\left({ }^{\circ} \mathbf{C}\right)$ | L (mm) | W <br> $(\mathbf{m m})$ | K0 <br> $(\boldsymbol{\mu m})$ | P1 <br> $(\mathbf{m m})$ | $\mathbf{C L}$ <br> $(\mathbf{m m})$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74ABTH32318PN | PN | LQFP | 80 | 119 | $7 \times 17$ | 150 | 315 | 135.9 | 7620 | 17.9 | 14.3 |
| $(\mathbf{m m})$ |  |  |  |  |  |  |  |  |  |  |  |



NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration MS-026.


NOTES: (continued)
4. Publication IPC-7351 may have alternate designs.
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
6. For more information, see Texas Instruments literature number SLMA004 (www.ti.com/lit/slma004).


SOLDER PASTE EXAMPLE BASED ON 0.1 mm THICK STENCIL

SCALE:6X

NOTES: (continued)
7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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